## **TECHNICAL DATA SHEET**



# NO CLEAN FLUX PEN

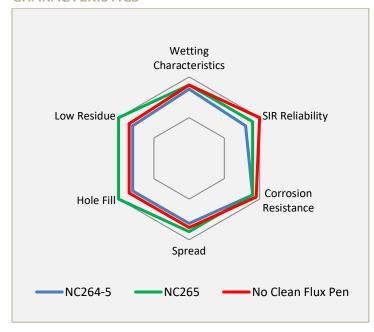
#### **FEATURES**

- Passes IPC SIR-004A and -004B Unheated
- Low Post Soldering Residue
- Compatible With All AIM Products
- Formulated Specifically For Rework
- Halide-Free

#### **DESCRIPTION**

AIM's NC Flux Pen contains a low- to medium-solids, no-clean liquid flux formulated to aid soldering with flux cored wire solder. NC Flux offers an excellent activity level for use on ENIG, ImSn, ImAg, bare copper, solder coated and OSP PCBs, leaving negligible post-process residues that are non-conductive and do not require post-process cleaning. NC Flux is safe to be left on the circuit board and passes IPC-004A and -004B SIR testing without thermal exposure.

#### **CHARACTERISTICS**





#### **HANDLING & STORAGE**

Parameter	Time	Temperature
Sealed Shelf Life	1 year	Room Temperature

Do not store near fire or flame. Keep away from sunlight as it may degrade the product. NC Flux Pen is shipped ready-to-use. Reseal any opened containers.

## **APPLICATION**

AIM's No Clean Flux Pen is designed to provide precise flux application control. Pump the pen to initiate flow of the flux to the tip. Apply flux only to area to be soldered avoiding flooding of the area.

Document Rev # NF2 Page 1 of 3

**DISCLAIMER** The information contained herein is based on data considered accurate and is offered at no charge. Product information is based upon the assumption of proper handling and operating conditions. Liability is expressly disclaimed for any loss or injury arising out of the use of this information or the use of any materials designated. Please refer to <a href="http://www.aimsolder.com/terms-conditions">http://www.aimsolder.com/terms-conditions</a> to review AIM's terms and conditions.

## **TECHNICAL DATA SHEET**



## **CLEANING**

NC Flux Pen can be cleaned using a saponifier or chemical cleaners. Deionized water is recommended for the final rinse. Contact AIM for additional information.

## **SAFETY**

Use with adequate ventilation and proper personal protective equipment. Refer to the accompanying Safety Data Sheet for any specific emergency information. Do not dispose of any hazardous materials in non-approved containers.

## **TEST DATA SUMMARY**

Name	Test Method	Results		
IPC Flux Classification	J-STD-004	ROL0		
IPC Flux Classification	J-STD-004B 3.3.1	ROL0		
Name	Test Method	Results	Image	
Copper Mirror	J-STD-004B 3.4.1.1 IPC-TM-650 2.3.32	LOW	RE IOT MANS	
Corrosion	J-STD-004B 3.4.1.2 IPC-TM-650 2.6.15	PASS	Before After	
Quantitative Halides	J-STD-004B 3.4.1.3 IPC-TM-650 2.3.28.1	0.0	Zero Halide	
Qualitative Halides, Fluoride Spot	J-STD-004B 3.5.1.2 IPC-TM-650 2.3.35.1	PASS	No Fluoride	
Surface Insulation	J-STD-004B 3.4.1.4 IPC-TM-650 2.6.3.7	PASS	Results available on request	
Resistance	J-STD-004 3.4.1.4 IPC-TM-650 2.6.3.3	PASS	Results available on request	
Electrochemical Migration	J-STD-004B 3.4.1.5 IPC-TM-650 2.6.14.1	PASS		

Document Rev # NF2 Page 2 of 3

**DISCLAIMER** The information contained herein is based on data considered accurate and is offered at no charge. Product information is based upon the assumption of proper handling and operating conditions. Liability is expressly disclaimed for any loss or injury arising out of the use of this information or the use of any materials designated. Please refer to <a href="http://www.aimsolder.com/terms-conditions">http://www.aimsolder.com/terms-conditions</a> to review AIM's terms and conditions.

# **TECHNICAL DATA SHEET**



Name	Test Method	Results	Image
Flux Solids, Nonvolatile Determination	J-STD-004B 3.4.2.1 IPC-TM-650 2.3.34	3.57% Typical	
Acid Value Determination	J-STD-004B 3.4.2.2 IPC-TM-650 2.3.13	12.82 mg KOH per gram flux Typical	
Flux Specific Gravity Determination	J-STD-004B 3.4.2.3 ASTM D-1298	0.79 (water = 1) Typical	
pH (1% solution /water)	ASTM D5464 ASTM G51	Acidic	
Visual	J-STD-004B 3.4.2.5	Light Yellow	

Document Rev # NF2 Page 3 of 3